



Technical Report

ISO/TR 23247-100

Automation systems and integration — Digital twin framework for manufacturing —

Part 100: Use case on management of semiconductor ingot growth process

*Systèmes d'automatisation industrielle et intégration —
Cadre technique de jumeau numérique dans un contexte de
fabrication —*

*Partie 100: Cas d'utilisation de la gestion du procédé de
croissance des lingots de semiconducteurs*

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